

# MBR350, MBR360

MBR360 is a Preferred Device

## Axial Lead Rectifiers

These devices employ the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

### Features

- Extremely Low  $v_F$
- Low Power Loss/High Efficiency
- Highly Stable Oxide Passivated Junction
- Low Stored Charge, Majority Carrier Conduction
- Pb-Free Packages are Available\*

### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.1 Gram (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Cathode indicated by Polarity Band

### MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	50 60	V
Average Rectified Forward Current $T_A = 65^\circ\text{C}$ ( $R_{\theta JA} = 28^\circ\text{C/W}$ , P.C. Board Mounting)	$I_O$	3.0	A
Non-Repetitive Peak Surge Current (Note 1) (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz, $T_L = 75^\circ\text{C}$ )	$I_{FSM}$	80	A
Operating and Storage Junction Temperature Range (Reverse Voltage Applied)	$T_J, T_{stg}$	-65 to +150	$^\circ\text{C}$

### THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Ambient (see Note 4 - Mounting Data, Mounting Method 3)	$R_{\theta JA}$	28	$^\circ\text{C/W}$
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Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

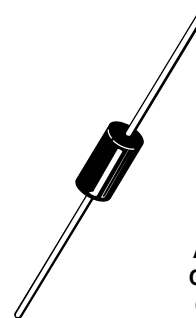
1. Lead Temperature reference is cathode lead 1/32 in from case.



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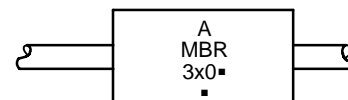
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**SCHOTTKY BARRIER  
RECTIFIERS  
3.0 AMPERES  
50, 60 VOLTS**



AXIAL LEAD  
CASE 267-05  
(DO-201AD)  
STYLE 1

### MARKING DIAGRAM



A = Assembly Location  
x = 5 or 6  
▪ = Pb-Free Package  
(Note: Microdot may be in either location)

### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

**Preferred** devices are recommended choices for future use and best overall value.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# MBR350, MBR360

## ELECTRICAL CHARACTERISTICS ( $T_L = 25^\circ\text{C}$ unless otherwise noted) (Note 2)

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (Note 3) ( $i_F = 1.0$ Amp) ( $i_F = 3.0$ Amp) ( $i_F = 9.4$ Amp)	$V_F$	0.600 0.740 1.080	V
Maximum Instantaneous Reverse Current @ Rated DC Voltage (Note 3) $T_L = 25^\circ\text{C}$ $T_L = 100^\circ\text{C}$	$i_R$	0.60 20	mA

- Lead Temperature reference is cathode lead 1/32 in from case.
- Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle = 2.0%.

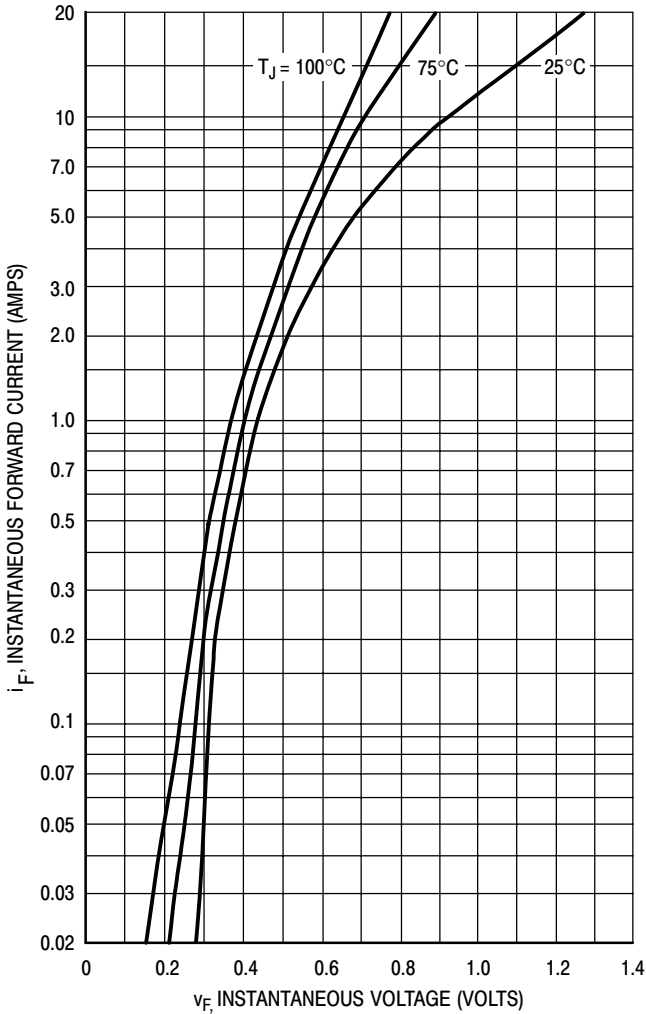


Figure 1. Typical Forward Voltage

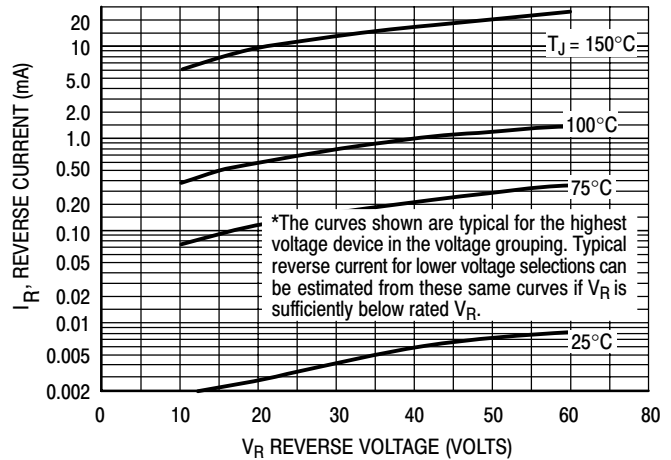


Figure 2. Typical Reverse Current\*

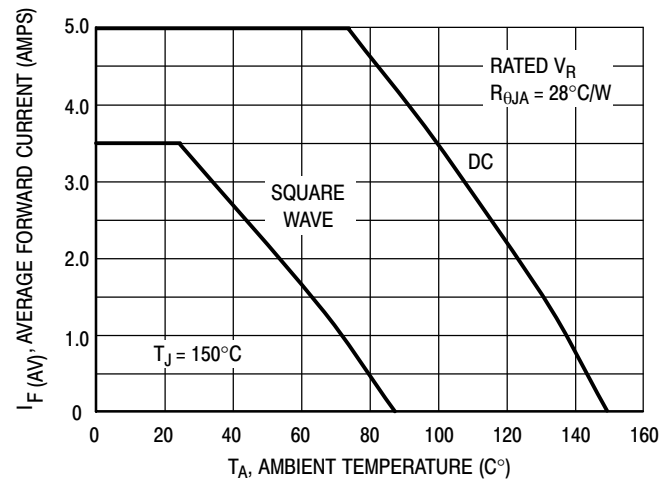
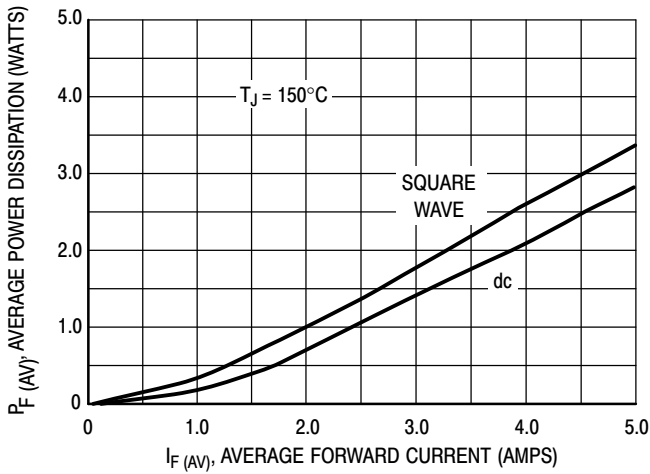
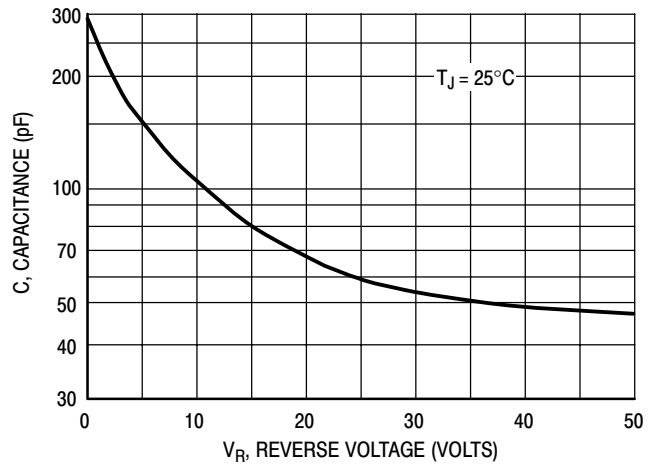


Figure 3. Current Derating Ambient  
(Mounting Method 3 per Note 4)

## MBR350, MBR360



**Figure 4. Power Dissipation**



**Figure 5. Typical Capacitance**

### NOTE 4 — MOUNTING DATA

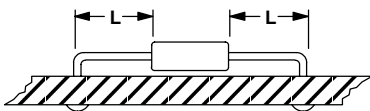
Data shown for thermal resistance, junction-to-ambient ( $R_{\theta JA}$ ) for the mountings shown is to be used as typical guideline values for preliminary engineering, or in case the tie point temperature cannot be measured.

#### TYPICAL VALUES FOR $R_{\theta JA}$ IN STILL AIR

Mounting Method	Lead Length, L (in)				$R_{\theta JA}$
	1/8	1/4	1/2	3/4	
1	50	51	53	55	$^{\circ}\text{C}/\text{W}$
2	58	59	61	63	$^{\circ}\text{C}/\text{W}$
3	28				$^{\circ}\text{C}/\text{W}$

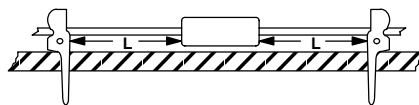
#### Mounting Method 1

P.C. Board where available copper surface is small.



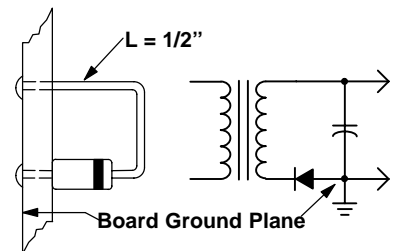
#### Mounting Method 2

Vector Push-In Terminals T-28



#### Mounting Method 3

P.C. Board with 2-1/2 in X 2-1/2 in copper surface.



### ORDERING INFORMATION

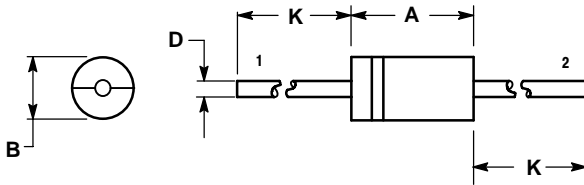
Device	Package	Shipping†
MBR350RL	Axial Lead	1500 Units / Tape & Reel
MBR350RLG	Axial Lead (Pb-Free)	1500 Units / Tape & Reel
MBR360	Axial Lead	500 Units / Bag
MBR360G	Axial Lead (Pb-Free)	500 Units / Bag
MBR360RL	Axial Lead	1500 Units / Tape & Reel
MBR360RLG	Axial Lead (Pb-Free)	1500 Units / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# MBR350, MBR360

## PACKAGE DIMENSIONS


### AXIAL LEAD CASE 267-05 (DO-201AD) ISSUE G



- NOTES:  
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.287	0.374	7.30	9.50
B	0.189	0.209	4.80	5.30
D	0.047	0.051	1.20	1.30
K	1.000	---	25.40	---

- STYLE 1:  
PIN 1. CATHODE (POLARITY BAND)  
2. ANODE

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